

N-Channel Enhancement Mode Field Effect Transistor

General Description

The 180N06 uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

Features

- Fast switching
- Low On-Resistance
- 100% avalanche tested
- RoHS Compliant

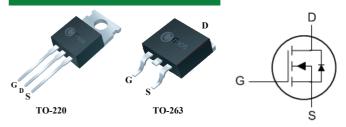
Product Summary

BVDSS	RDSON	ID
60V	4mΩ	180A

Applications

- Power switching application
- Uninterruptible power supply
- Hard switched and high frequency circuits

TO-220/263 Pin Configuration



Туре	Package	Marking		
CMP180N06	TO-220	CMP180N06		
CMB180N06	TO-263	CMB180N06		

Absolute Maximum Ratings

Symbol	Symbol Parameter		Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current	180	Α
I _D @T _C =100℃	Continuous Drain Current	116	Α
I _{DM}	Pulsed Drain Current ¹	540	Α
EAS	Single Pulse Avalanche Energy ²	950	mJ
P _D @T _C =25℃	Total Power Dissipation	250	W
T _{STG}	Storage Temperature Range	-55 to 150	$^{\circ}$
T_J	Operating Junction Temperature Range	-55 to 150	${\mathbb C}$

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-ambient		62.5	°C/W
R _{θJC}	Thermal Resistance Junction-case		0.51	°C/W

CMP180N06/CMB180N06



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Electrical Characteristics (T $_J$ =25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =25A			4	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	2		4	V
	Drain Source Leakage Current	V _{DS} =60V, V _{GS} =0V			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =48V , V _{GS} =0V,T _J =125 °C			100	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =10V , I _D =30A		32		S
Qg	Total Gate Charge	I _D =90A		86		
Q _{gs}	Gate-Source Charge	V _{DD} =48V		22		nC
Q _{gd}	Gate-Drain Charge	V _{GS} =10 V		30		
T _{d(on)}	Turn-On Delay Time	V _{GS} =10V		38		
T _r	Rise Time	V _{DD} =30V		23		20
T _{d(off)}	Turn-Off Delay Time	I _D =90A		70		ns
T _f	Fall Time	$R_G=6\Omega$		23.5		
C _{iss}	Input Capacitance			5800		
C _{oss}	Output Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz		635		pF
C _{rss}	Reverse Transfer Capacitance			345		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V , Force Current			180	А
I _{SM}	Pulsed Source Current ¹				540	Α
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =30 A , T _J =25℃			1.2	٧
t _{rr}	Reverse Recovery Time	V _{GS} =0V , I _S =90A		36		ns
Qrr	Reverse Recovery Charge	dI _F /dt =100A/μ		41		μС

1.Repetitive rating; pulse width limited by max. junction temperature.

2.The test condition is $V_{\text{DD}}\text{=}30\text{V}$, $V_{\text{GS}}\text{=}10\text{V}$, L=1 mH , $I_{\text{AS}}\text{=}49\text{A}$

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